

ABSTRACT OF THE DISCLOSURE

A heat sink module includes a heat dissipation pad. The heat dissipation pad is flexible and has a cambered shape, and is pressed to become a flat plate when disposed between the heat sink module and a CPU. The heat dissipation pad restores to its original cambered shape and lifts the heat sink module away from a CPU when a fixing device that fixes the heat sink module to the CPU is disabled. Therefore, one can easily remove the heat sink module without any additional tools or processes.